

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
REQUEST FOR FILING APPLICATION UNDER 35 U.S.C. 1.53(b)  
WITH FILING FEE OR EXECUTED INVENTOR'S OATH/DECLARATION

Assistant Commissioner for Patents  
Washington, DC 20231

Atty. Dkt. 925-177

Date: February 7, 2001

Sir:



02/07/01

Jc971 U.S. PTO  
09/778045  
02/07/01

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled:

**SEMICONDUCTOR LIGHT-EMITTING DEVICE AND MANUFACTURING METHOD THEREFOR**

without a filing fee and/or without an executed inventor's oath/declaration.

This application is made by the below identified inventor(s). Attached hereto are the following papers:

- ☒ An abstract together with  
42 pages of specification and claims including  
14 numbered claims and also attached is/are  
24 sheets of accompanying drawings.  
☒ This application is based on the following prior foreign application(s):

Application No.	Country
2000-029030	JAPAN
2000-372776	JAPAN

Filing Date
7 February 2000
7 December 2000

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☐ This application is based on the following prior provisional application(s):  
Application No. Filing Date

respectively, the entire content of which is hereby incorporated by reference in this application, and priority is hereby claimed therefrom.

- ☒ Certified copy/ies of foreign applications attached.

This application is a ☐ continuation/☐ division/☐ continuation-in-part of application Serial No. , filed  
Please amend the specification by inserting before the first line: --This application is a ☐ continuation/☐ division/  
☐ continuation-in-part of application Serial No. , filed , the entire content of which is hereby incorporated by  
reference in this application.--

Please amend the specification by inserting before the first line: --This is a continuation of PCT application No.  
, filed , the entire content of which is hereby incorporated by reference in this application.--

Please amend the specification by inserting before the first line: --This application claims the benefit of U.S.  
Provisional Application No. , filed , the entire content of which is hereby incorporated by reference in this  
application.--

Preliminary amendment to claims (attached hereto), to be entered before calculation of the fee.

Also attached: ☒ Information Disclosure Statement ; ☐ Non-Publication Request; ☐ Other:

Inventor: Takahisa KURAHASHI Japan  
(first) MI (last) (citizenship)  
Residence: (city) Nara-ken (state/country) Japan  
Mailing Address: 12-13, Mamigaoka 5-chome, Kashiba-shi, Nara-ken, Japan  
(Zip Code)

2. Inventor: Hiroyuki HOSOBABA Japan  
(first) MI (last) (citizenship)  
Residence: (city) Kyoto-fu (state/country) Japan  
Mailing Address: 2-1-1-4-105, Kabutodai, Kizu-cho, Souraku-gun, Kyoto-fu, Japan  
(Zip Code)

☒ See attached sheet(s) for additional inventor(s) information!!

Address all future communications to NIXON & VANDERHYE P.C., 1100 North Glebe Road, 8<sup>th</sup> Floor, Arlington,  
Virginia 22201.

1100 North Glebe Road, 8<sup>th</sup> Floor  
Arlington, Virginia 22201-4714  
Telephone: (703) 816-4000  
Facsimile: (703) 816-4100  
HWB:ms

NIXON & VANDERHYE P.C.

By Atty: H. Warren Burnam, Jr., Reg. No. 29,366

Signature:

3. Inventor: Hiroshi (first) MI NAKATSU (last) Japan (citizenship)  
Residence: (city) Nara-ken (state/country) Japan  
Mailing Address: 139-1-413, Aramaki-cho, Tenri-shi, Nara-ken, Japan  
(Zip Code)
4. Inventor: Tetsurou (first) MI MURAKAMI (last) Japan (citizenship)  
Residence: (city) Nara-ken (state/country) Japan  
Mailing Address: Raporu-Tenri 1001, 2613-1, Ichinomoto-cho, Tenri-shi, Nara-ken, Japan  
(Zip Code)
5. Inventor: Shouichi (first) MI OHYAMA (last) Japan (citizenship)  
Residence: (city) Nara-ken (state/country) Japan  
Mailing Address: 189-1, Higashi-ando, Ando-cho, Ikoma-gun, Nara-ken, Japan  
(Zip Code)

09738045-020701